

DATASHEET

LAMP 209SURUBC/S530-A3/R2



Features

- Two chips are matched for uniform light output, wide viewing angle
- · Long life-solid state reliability
- I.C. compatible/Low power consumption
- · Pb free
- The product itself will remain within RoHS compliant version

Description

- The 209 LED lamp contain two integral chips and is available as both bicolor and bipolar types.
- The Brilliant Red and Brilliant Orange light is emitted by diodes of AlGalnP and InGaN/SiC.
- Type of bipolar lamps are both White Diffused and Water Clear while the bicolor are White Diffused.

Applications

- TV set
- Monitor
- Telephone
- Computer

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Device Selection Guide

Chip Materials	Emitted Color	Resin Color	
AlGalnP	Brilliant Red	Water Clear	
InGaN/SiC	Blue	vvater Clear	

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating		Unit	
Continuous Forward Current	I _F	SUR/S530	25	mA	
Continuodo i ci wara carrent	'F	UB/C470	25	110/1	
	I _{FP}	SUR/S530	60		
Peak Forward Current (Duty 1/10 @ 1KHZ)		UB/C470	100	mA	
Reverse Voltage	V_R	5		V	
Davies Dissination	Pd	SUR/S530	60		
Power Dissipation		UB/C470	110	mW	
Operating Temperature	T _{opr}	-40 ~ +85			
Storage Temperature	Tstg	-40 ~ +100			
Soldering Temperature	T _{sol}		26	for 5 sec.	

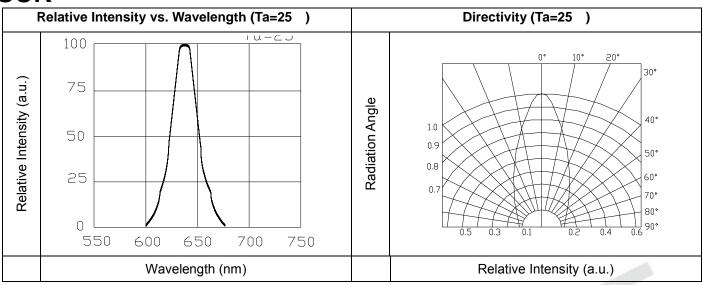
Electro-Optical Characteristics (Ta=25)

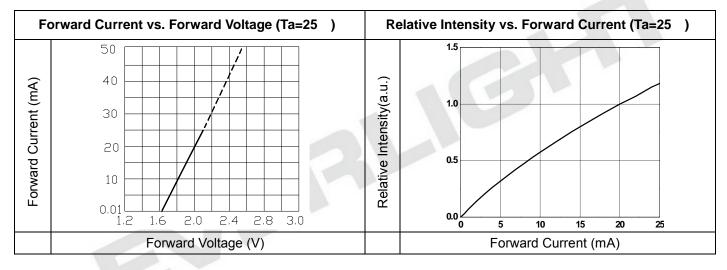
Parameter	S	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V _F	SUR/S530	1.7	2.0	2.4	V	I _F =20mA
Forward Voltage	VF	UB/C470	2.7	3.3	3.7	V	IF-ZUITA
Reverse Current	I _R	SUR/S530			10	μA	V _R =5V
		UB/C470			50		
Luminous Intensity	I _V	SUR/S530	1	2		mcd	I _F =20mA
		UB/C470	0.25	0.5			
Viewing Angle	201/2	SUR/S530		40		deg	I _F =20mA
		UB/C470		40			
Peak Wavelength	р	SUR/S530		632		nm	I _F =20mA
		UB/C470		468			
Dominant Wavelength	d	SUR/S530		624		- nm	I _F =20mA
		UB/C470		470			
Spectrum Radiation Bandwidth		SUR/S530		20		nm	I _F =20mA
		UB/C470		35		11111	IF-ZUITA

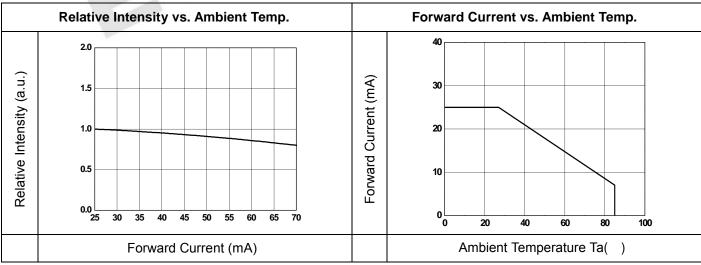


Typical Electro-Optical Characteristics Curves

SUR

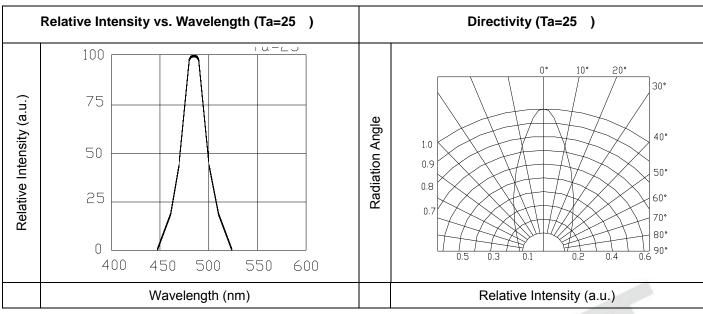


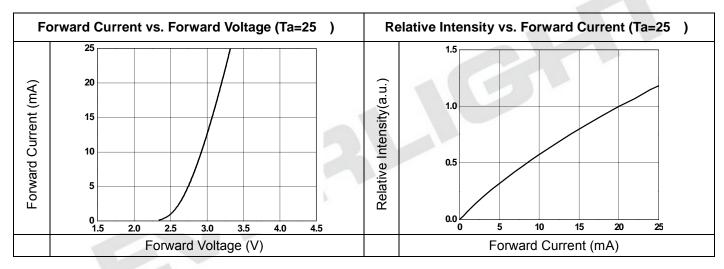


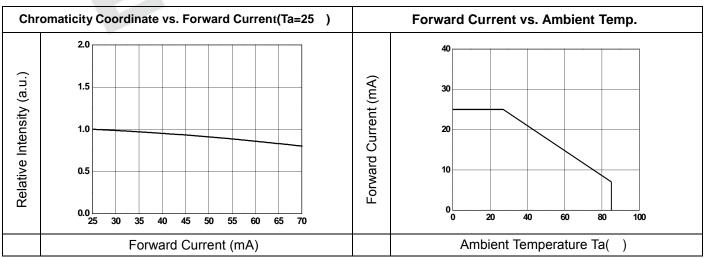




UB

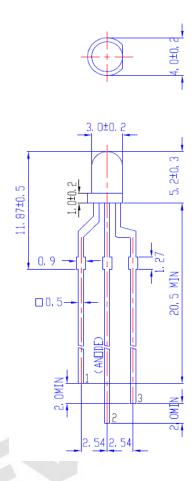


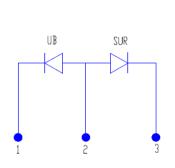






Package Dimension





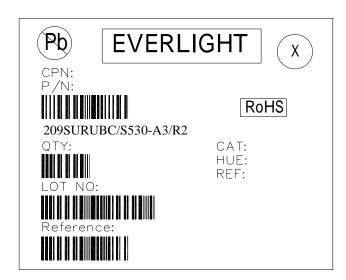
Note: Note:

- 1. All dimensions are in millimeters
- 2. The height of flange must be less than 1.5mm(0.059").
- 3. Without special declared, the tolerance is ± 0.25 mm.



Moisture Resistant Packing Materials

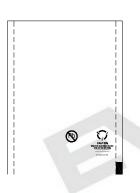
Label Explanation



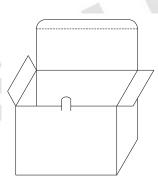
- · CPN: Customer's Production Number
- P/N : Production Number
- · QTY: Packing Quantity
- · CAT: Ranks of Luminous Intensity and Forward Voltage
- · HUE: Color Rank
- · REF: Reference
- · LOT No: Lot Number

Packing Specification

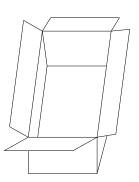
Anti-electrostatic bag



Inner Carton



Outside Carton



- Packing Quantity
 - 1.500 PCS/1 Bag, 4 Bags/1 Inner Carton
 - 2. 10 Inner Cartons/1 Outside Carton



Notes

Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

2. Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

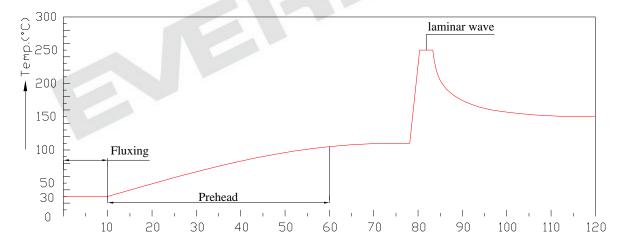
Soldering

Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.

Recommended soldering conditions:

Hand Soldering		DIP Soldering			
Temp. at tip of iron	300 Max. (30W Max.)	Preheat temp.	100 Max. (60 sec Max.)		
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max		
Distance	3mm Min.(From solder	Distance	3mm Min. (From solder		
	joint to epoxy bulb)		joint to epoxy bulb)		

■ Recommended soldering profile



- Avoiding applying any stress to the lead frame while the LEDs are affigh temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest

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possible temperature is desirable for the LEDs.

Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED

5. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

ESD (Electrostatic Discharge)

The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.

When handling the products, the following measures against electrostatic discharge are strongly recommended:

Eliminating the charge

Grounded wrist strap, ESD footwear, clothes, and floors

Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

Proper grounding is required for all devices, equipment, and machinery used in product assembly.

Surge protection should be considered when designing of commercial products.

If tools or equipment contain insulating materials such as glass or plastic,

the following measures against electrostatic discharge are strongly recommended:

Dissipating static charge with conductive materials

Preventing charge generation with moisture

Neutralizing the charge with ionizers

7. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply

with the absolute maximum ratings and the instructions included in these specification sheets.

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Expired Period: Forever

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SML-LX0606SISUGC/A SML-LXL1307SRC-TR SML-LXR851SIUPGUBC LT1ED53A AM27ZGC03 APB3025SGNC
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SML-LX2835SYSUGCTR CLMUC-FKA-CL81C1L51BB7C3C3